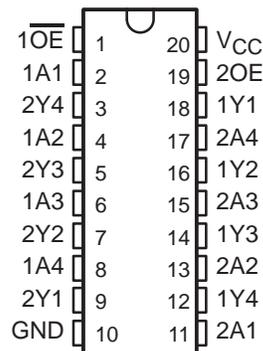


# SN64BCT241 OCTAL BUFFER/DRIVER WITH 3-STATE OUTPUTS

SCBS046C – FEBRUARY 1990 – REVISED JULY 1998

- State-of-the-Art BiCMOS Design Substantially Reduces Standby Current
- 3-State Outputs Drive Bus Lines or Buffer-Memory Address Registers
- ESD Protection Exceeds 2000 V Per MIL-STD-883 Method 3015
- High-Impedance State During Power Up and Power Down
- Package Options Include Small-Outline (DW) and Standard Plastic DIPs (N)

DW OR N PACKAGE  
(TOP VIEW)



## description

This octal buffer and line driver is designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. With the SN64BCT240 and SN64BCT244, these devices provide the choice of selected combinations of inverting and noninverting outputs, symmetrical active-low output-enable ( $\overline{OE}$ ) inputs, and complementary OE and  $\overline{OE}$  inputs.

The SN64BCT241 is characterized for operation from  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$  and  $0^{\circ}\text{C}$  to  $70^{\circ}\text{C}$ .

FUNCTION TABLES

INPUTS		OUTPUT
$\overline{1OE}$	1A	1Y
L	H	H
L	L	L
H	X	Z

INPUTS		OUTPUT
2OE	2A	2Y
H	H	H
H	L	L
L	X	Z



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS  
INSTRUMENTS**

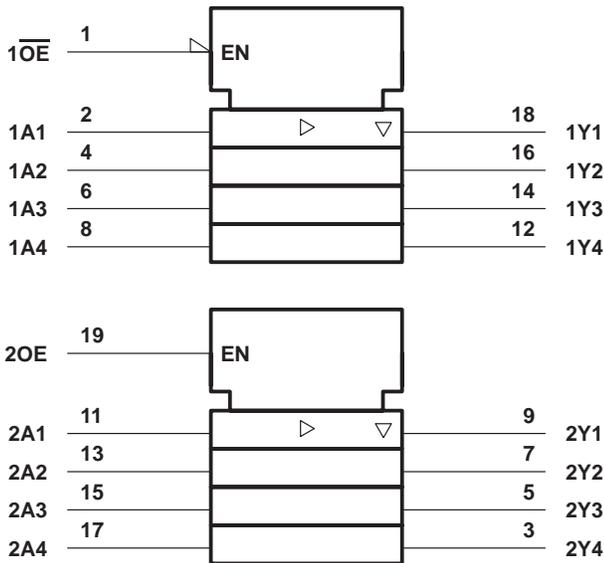
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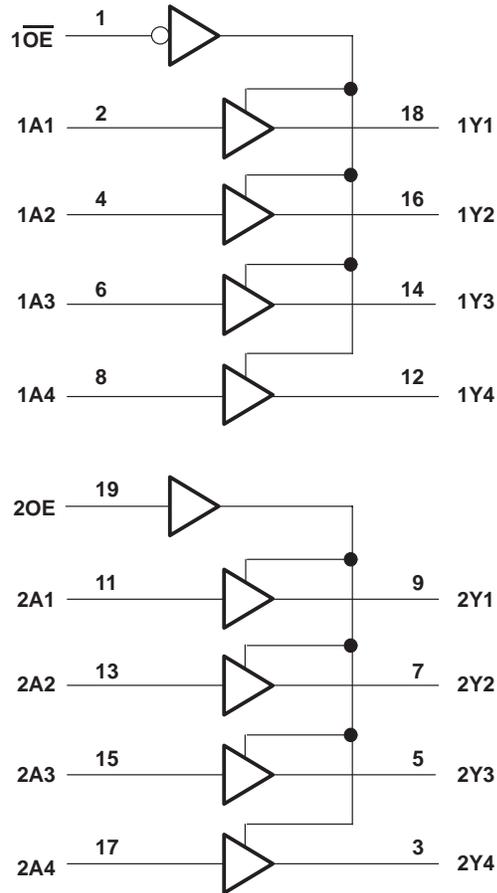
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## logic symbol†



## logic diagram (positive logic)



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, $V_{CC}$ .....	- 0.5 V to 7 V
Input voltage range, $V_I$ (see Note 1) .....	- 0.5 V to 7 V
Voltage range applied to any output in the disabled or power-off state, $V_O$ .....	- 0.5 V to 5.5 V
Voltage range applied to any output in the high state, $V_O$ .....	- 0.5 V to $V_{CC}$
Current into any output in the low state, $I_O$ .....	128 mA
Package thermal impedance, $\theta_{JA}$ (see Note 2): DW package .....	97°C/W
N package .....	67°C/W
Storage temperature range, $T_{stg}$ .....	- 65°C to 150°C

‡ Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input negative voltage rating may be exceeded if the input clamp current rating is observed.

2. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.

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**recommended operating conditions (see Note 3)**

		MIN	NOM	MAX	UNIT
$V_{CC}$	Supply voltage	4.5	5	5.5	V
$V_{IH}$	High-level input voltage	2			V
$V_{IL}$	Low-level input voltage			0.8	V
$I_{IK}$	Input clamp current			-18	mA
$I_{OH}$	High-level output current			-15	mA
$I_{OL}$	Low-level output current			64	mA
$T_A$	Operating free-air temperature	-40		85	°C

NOTE 3: All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER		TEST CONDITIONS		MIN	TYP†	MAX	UNIT
$V_{IK}$		$V_{CC} = 4.5\text{ V}$ ,	$I_I = -18\text{ mA}$			-1.2	V
$V_{OH}$		$V_{CC} = 4.5\text{ V}$	$I_{OH} = -3\text{ mA}$	2.4	3.3		V
			$I_{OH} = -15\text{ mA}$	2	3.1		
		$V_{CC} = 4.75\text{ V}$ ,	$I_{OH} = -3\text{ mA}$	2.7			
$V_{OL}$		$V_{CC} = 4.5\text{ V}$ ,	$I_{OH} = 64\text{ mA}$	0.42	0.55		V
$I_{OZH}$		$V_{CC} = 5.5\text{ V}$ ,	$V_O = 2.7\text{ V}$			50	$\mu\text{A}$
$I_{OZL}$		$V_{CC} = 5.5\text{ V}$ ,	$V_O = 0.5\text{ V}$			-50	$\mu\text{A}$
$I_{OZ}$	$\overline{1OE}$ at 0.8 V, $2OE$ at 2 V	$V_{CC} = 0$ to 2.3 V (power up)	$V_O = 2.7\text{ V}$ or 0.5 V,			$\pm 50$	$\mu\text{A}$
		$V_{CC} = 1.8\text{ V}$ to 0 (power down)				$\pm 50$	
$I_I$		$V_{CC} = 5.5\text{ V}$ ,	$V_I = 7\text{ V}$			0.1	mA
$I_{IH}$		$V_{CC} = 5.5\text{ V}$ ,	$V_I = 2.7\text{ V}$			20	$\mu\text{A}$
$I_{IL}$	$\overline{1OE}$ or $\overline{2OE}$	$V_{CC} = 5.5\text{ V}$ ,	$V_I = 0.5\text{ V}$			-1	mA
	Any A input					-1.6	
$I_{OS}‡$		$V_{CC} = 5.5\text{ V}$ ,	$V_O = 0$	-100		-225	mA
$I_{CCL}$		$V_{CC} = 5.5\text{ V}$ ,	Output open		23	43	mA
$I_{CCH}$		$V_{CC} = 5.5\text{ V}$ ,	Output open		53	85	mA
$I_{CCZ}$		$V_{CC} = 5.5\text{ V}$ ,	Output open		4	10	mA
$C_i$		$V_{CC} = 5\text{ V}$ ,	$V_I = 2.5\text{ V}$ or 0.5 V		6		pF
$C_o$		$V_{CC} = 5\text{ V}$ ,	$V_O = 2.5\text{ V}$ or 0.5 V		11		pF

† All typical values are at  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

‡ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

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**switching characteristics (see Figure 1)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> = 5 V, C <sub>L</sub> = 50 pF, R <sub>1</sub> = 500 Ω, R <sub>2</sub> = 500 Ω, T <sub>A</sub> = 25°C		V <sub>CC</sub> = 4.5 V to 5.5 V, C <sub>L</sub> = 50 pF, R <sub>1</sub> = 500 Ω, R <sub>2</sub> = 500 Ω				UNIT
					T <sub>A</sub> = -40°C to 85°C		T <sub>A</sub> = 0°C to 70°C		
			MIN	MAX	MIN	MAX	MIN	MAX	
t <sub>PLH</sub>	A	Y	0.5	4.5	0.5	5.2	0.5	4.9	ns
t <sub>PHL</sub>			1	5.4	1	6.3	1	5.9	
t <sub>PZH</sub>	1OE or 2OE	Y	1	7.8	1	9.1	1	8.7	ns
t <sub>PZL</sub>			1	8.6	1	10	1	9.4	
t <sub>PHZ</sub>	1OE or 2OE	Y	1	6.8	1	8.4	1	8.1	ns
t <sub>PLZ</sub>			1	8.1	1	11	1	9.9	





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